

SEMIFACK

Thyristor Modules

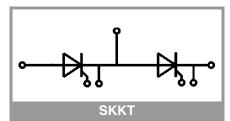
SKKT 58B16 E

Features

- Heat transfer through aluminium oxide ceramic isolated metal baseplate
- UL recognized, file no. E63532

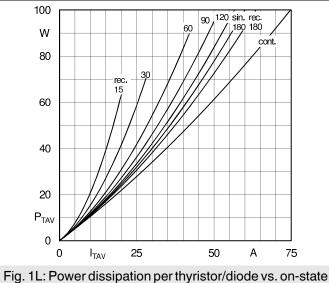
Typical Applications*

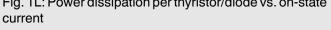
- DC motor control (e. g. for machine tools)
- AC motor soft starters
- Temperature control (e. g. for ovens, chemical processes)
- Professional light dimming (studios, theaters)

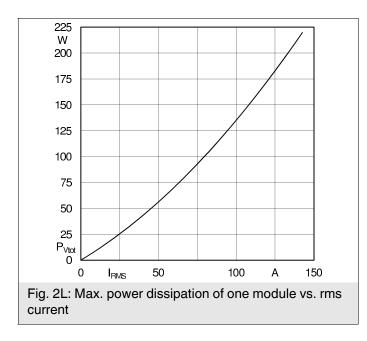


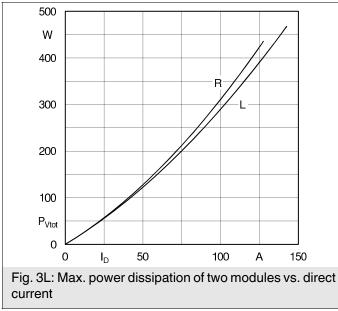
Absolute Maximum Ratings							
Symbol	Conditions		Values	Unit			
Chip				•			
I _{T(AV)}	sinus 180°	T _c = 85 °C	55	А			
		T _c = 100 °C	41	А			
I _{TRMS}	continuous operation		90	А			
I _{TSM}	- 10 ms	T _j = 25 °C	1500	А			
		T _j = 130 °C	1200	А			
i ² t	10 ms	T _j = 25 °C	11250	A ² s			
		T _j = 130 °C	7200	A²s			
V _{RSM}			1700	V			
V _{RRM}			1600	V			
V _{DRM}			1600	V			
(di/dt) _{cr}	T _j = 130 °C		140	A/μs			
(dv/dt) _{cr}	T _j = 130 °C		1000	V/µs			
Tj			-40 130	°C			
Module			·	•			
T _{stg}			-40 125	°C			
V _{isol}	a.c.; 50 Hz; r.m.s.	1 min	3000	V			
		1 s 3600		V			

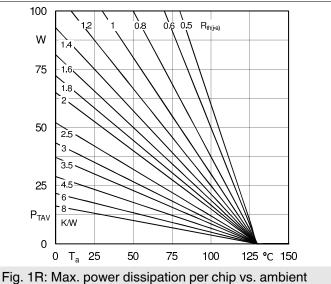
Characte	eristics					
Symbol	Conditions	min.	typ.	max.	Unit	
Chip						
V _T	T _j = 25 °C, I _T = 180 A			1.5	1.75	V
V _{T(TO)}	T _j = 130 °C			0.85	1	V
r _T	T _j = 130 °C			4.00	4.8	mΩ
I _{DD} ;I _{RD}	$T_j = 130 \text{ °C}, V_{DD} = V_{DRM}; V_{RD} = V_{RRM}$				20	mA
t _{gd}	$T_j = 25 \text{ °C}, I_G = 1 \text{ A}, di_G/dt = 1 \text{ A}/\mu \text{s}$			1		μs
t _{gr}	$V_{D} = 0.67 * V_{DRM}$			2		μs
t _q	T _j = 130 °C			170		μs
I _H	T _j = 25 °C			150	250	mA
IL.	$T_j = 25 \ ^{\circ}C, R_G = 33 \ \Omega$			300	600	mA
V_{GT}	$T_j = 25 \ ^{\circ}C, \ d.c.$		2.5			V
I _{GT}	$T_{j} = 25 \ ^{\circ}C, \ d.c.$		100			mA
V_{GD}	$T_j = 130 \ ^{\circ}C, \ d.c.$				0.25	V
I _{GD}	$T_j = 130 \ ^{\circ}C, \ d.c.$				4	mA
R _{th(j-c)}	continuous DC	per chip			0.47	K/W
		per module			0.235	K/W
R _{th(j-c)}	sin. 180°	per chip			0.49	K/W
		per module			0.245	K/W
R _{th(j-c)}	– rec. 120°	per chip			0.51	K/W
		per module			0.255	K/W
Module						
R _{th(c-s)}	_{c-s)} chip			0.22		K/W
	module			0.11		K/W
Ms	to heatsink M5		4.25		5.75	Nm
Mt	to terminals M5		2.55		3.45	Nm
а					5 * 9,81	m/s²
w				75		g



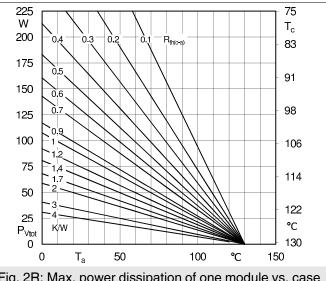














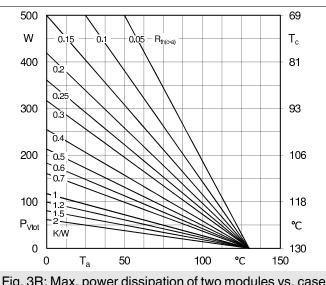
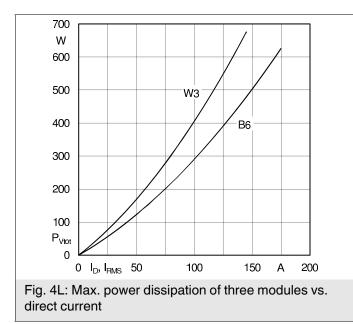
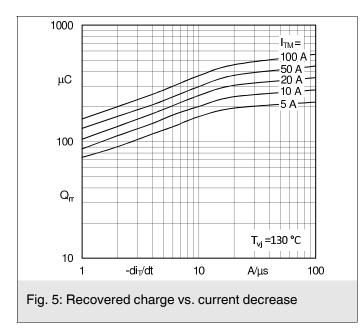
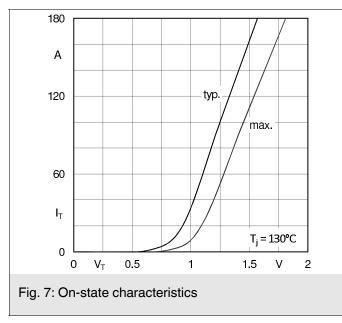


Fig. 3R: Max. power dissipation of two modules vs. case temperature







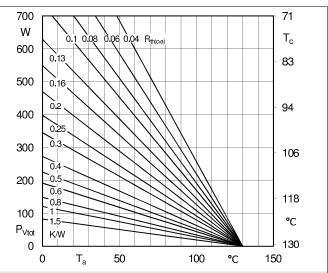


Fig. 4R: Max. power dissipation of three modules vs. case temperature

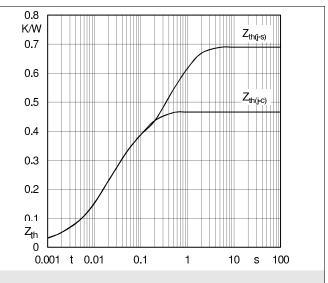
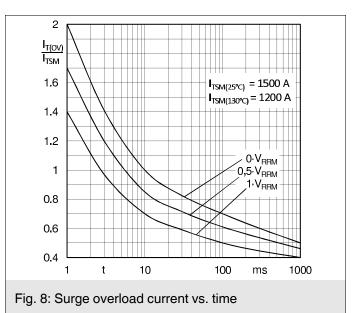
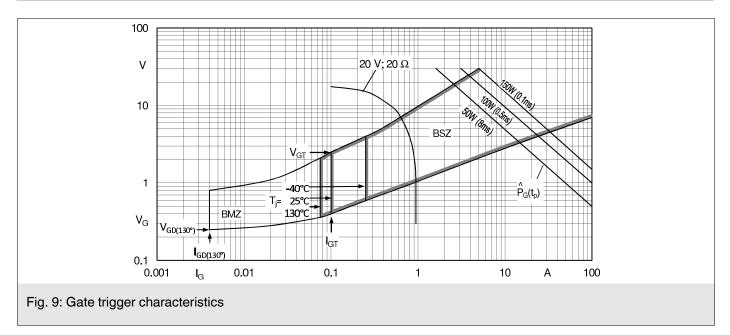
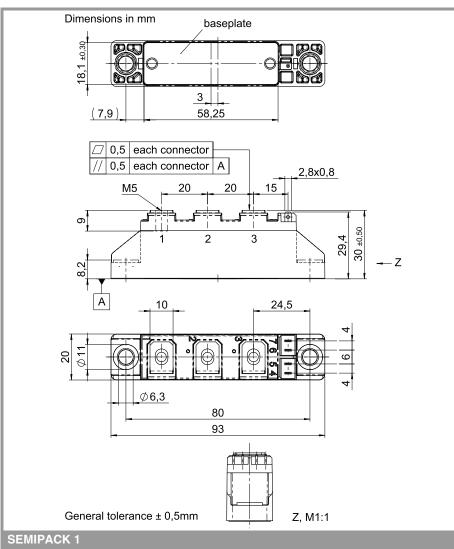


Fig. 6: Transient thermal impedance vs. time



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This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, chapter IX.

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